



PATENT

**In the United States Patent and Trademark Office**

Applicant: Ravkin et al. )  
Applicant's Ref: LAM2P428 )  
Application No: 10/607,611 )  
Filed: June 27, 2003 )  
Title: APPARATUS AND METHOD FOR )  
DEPOSITING AND PLANARIZING THIN )  
FILMS OF SEMICONDUCTOR WAFERS )

Examiner: Unassigned  
Group Art Unit: 2812  
Date: November 12, 2003

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450 on November 12, 2003.

Signed: \_\_\_\_\_

Kay Harlow


**Separate Letter to the Official Draftsperson**

Commissioner for Patents  
Mail Stop PGPUB Drawings  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Notice to File Missing Parts dated September 22, 2003, indicating that formal drawings are now required, enclosed herewith are the formal drawings (Figures 1A, 1B, 1C, 1D, 2A, 2B, 2C, 2D, 3 and 4), for the above-referenced case. If the draftsperson has any questions concerning these drawings, please contact the undersigned at the number set forth below. If any fees are due in connection with the filing of these drawings, please charge such fees to deposit account 50-0805 (Order No. LAM2P428).

Respectfully submitted,  
MARTINE & PENILLA, LLP

  
Albert S. Penilla, Esq.  
Reg. No. 39,487

710 Lakeway Drive, Suite 170  
Sunnyvale, CA 94085  
(408) 749-6900

**Customer Number 25920**

Attorney Docket No: LAM2P428